

### General Description

The AO4406A uses advanced trench technology to provide excellent  $R_{DS(ON)}$  with low gate charge. This device is suitable for high side switch in SMPS and general purpose applications.

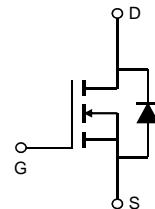
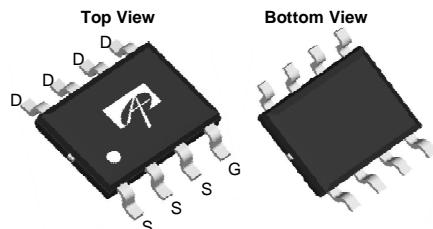
### Product Summary

|                                    |          |
|------------------------------------|----------|
| $V_{DS}$                           | 30V      |
| $I_D$ (at $V_{GS}=10V$ )           | 13A      |
| $R_{DS(ON)}$ (at $V_{GS}=10V$ )    | < 11.5mΩ |
| $R_{DS(ON)}$ (at $V_{GS} = 4.5V$ ) | < 15.5mΩ |

100% UIS Tested  
100%  $R_g$  Tested



SOIC-8



### Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

| Parameter                               | Symbol         | Maximum    | Units |
|---|----------------|------------|-------|
| Drain-Source Voltage                    | $V_{DS}$       | 30         | V     |
| Gate-Source Voltage                     | $V_{GS}$       | $\pm 20$   | V     |
| Continuous Drain Current <sup>A</sup>   | $I_D$          | 13         | A     |
| $T_A=70^\circ C$                        |                | 10.4       |       |
| Pulsed Drain Current <sup>C</sup>       | $I_{DM}$       | 100        |       |
| Avalanche Current <sup>C</sup>          | $I_{AS}$       | 22         | A     |
| Avalanche energy $L=0.1mH$ <sup>C</sup> | $E_{AS}$       | 24         | mJ    |
| Power Dissipation <sup>B</sup>          | $P_D$          | 3.1        | W     |
| $T_A=70^\circ C$                        |                | 2          |       |
| Junction and Storage Temperature Range  | $T_J, T_{STG}$ | -55 to 150 | °C    |

### Thermal Characteristics

| Parameter  | Symbol          | Typ | Max | Units |
|--|-----------------|-----|-----|-------|
| Maximum Junction-to-Ambient <sup>A</sup><br>$t \leq 10s$   | $R_{\theta JA}$ | 31  | 40  | °C/W  |
| Maximum Junction-to-Ambient <sup>A,D</sup><br>Steady-State |                 | 59  | 75  | °C/W  |
| Maximum Junction-to-Lead                                   | $R_{\theta JL}$ | 16  | 24  | °C/W  |

**Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

| Symbol                      | Parameter                             | Conditions   | Min | Typ       | Max        | Units            |
|-----------------------------|---------------------------------------|--|-----|-----------|------------|------------------|
| <b>STATIC PARAMETERS</b>    |                                       |  |     |           |            |                  |
| $\text{BV}_{\text{DSS}}$    | Drain-Source Breakdown Voltage        | $I_D=250\mu\text{A}, V_{GS}=0\text{V}$   | 30  |           |            | V                |
| $I_{\text{DSS}}$            | Zero Gate Voltage Drain Current       | $V_{DS}=30\text{V}, V_{GS}=0\text{V}$<br>$T_J=55^\circ\text{C}$                |     |           | 1<br>5     | $\mu\text{A}$    |
| $I_{\text{GSS}}$            | Gate-Body leakage current             | $V_{DS}=0\text{V}, V_{GS}=\pm20\text{V}$                                       |     |           | $\pm100$   | nA               |
| $V_{\text{GS(th)}}$         | Gate Threshold Voltage                | $V_{DS}=V_{GS}, I_D=250\mu\text{A}$  | 1.5 | 1.9       | 2.5        | V                |
| $I_{\text{D(ON)}}$          | On state drain current                | $V_{GS}=10\text{V}, V_{DS}=5\text{V}$  | 100 |           |            | A                |
| $R_{\text{DS(ON)}}$         | Static Drain-Source On-Resistance     | $V_{GS}=10\text{V}, I_D=12\text{A}$<br>$T_J=125^\circ\text{C}$                 |     | 9.5<br>14 | 11.5<br>17 | $\text{m}\Omega$ |
|                             |                                       | $V_{GS}=4.5\text{V}, I_D=10\text{A}$   |     | 12.5      | 15.5       | $\text{m}\Omega$ |
| $g_{\text{FS}}$             | Forward Transconductance              | $V_{DS}=5\text{V}, I_D=12\text{A}$   |     | 45        |            | S                |
| $V_{\text{SD}}$             | Diode Forward Voltage                 | $I_S=1\text{A}, V_{GS}=0\text{V}$  |     | 0.75      | 1          | V                |
| $I_S$                       | Maximum Body-Diode Continuous Current |  |     |           | 4          | A                |
| <b>DYNAMIC PARAMETERS</b>   |                                       |  |     |           |            |                  |
| $C_{\text{iss}}$            | Input Capacitance                     | $V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$                           | 610 | 760       | 910        | pF               |
| $C_{\text{oss}}$            | Output Capacitance                    |  | 88  | 125       | 160        | pF               |
| $C_{\text{rss}}$            | Reverse Transfer Capacitance          |  | 40  | 70        | 100        | pF               |
| $R_g$                       | Gate resistance                       | $V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$                            | 0.8 | 1.6       | 2.4        | $\Omega$         |
| <b>SWITCHING PARAMETERS</b> |                                       |  |     |           |            |                  |
| $Q_g(10\text{V})$           | Total Gate Charge                     | $V_{GS}=10\text{V}, V_{DS}=15\text{V}, I_D=12\text{A}$                         | 11  | 14        | 17         | nC               |
| $Q_g(4.5\text{V})$          | Total Gate Charge                     |  | 5   | 6.6       | 8          | nC               |
| $Q_{\text{gs}}$             | Gate Source Charge                    |  | 1.9 | 2.4       | 2.9        | nC               |
| $Q_{\text{gd}}$             | Gate Drain Charge                     |  | 1.8 | 3         | 4.2        | nC               |
| $Q_{\text{gs}}$             | Gate Source Charge                    | $V_{GS}=4.5\text{V}, V_{DS}=15\text{V}, I_D=12\text{A}$                        | 1.9 | 2.4       | 2.9        | nC               |
| $Q_{\text{gd}}$             | Gate Drain Charge                     |  | 1.8 | 3         | 4.2        | nC               |
| $t_{\text{D(on)}}$          | Turn-On DelayTime                     | $V_{GS}=10\text{V}, V_{DS}=15\text{V}, R_L=1.25\Omega, R_{\text{GEN}}=3\Omega$ |     | 4.4       |            | ns               |
| $t_r$                       | Turn-On Rise Time                     |  |     | 9         |            | ns               |
| $t_{\text{D(off)}}$         | Turn-Off DelayTime                    |  |     | 17        |            | ns               |
| $t_f$                       | Turn-Off Fall Time                    |  |     | 6         |            | ns               |
| $t_{\text{rr}}$             | Body Diode Reverse Recovery Time      | $I_F=12\text{A}, dI/dt=500\text{A}/\mu\text{s}$                                | 5.6 | 7         | 8          | ns               |
| $Q_{\text{rr}}$             | Body Diode Reverse Recovery Charge    | $I_F=12\text{A}, dI/dt=500\text{A}/\mu\text{s}$                                | 6.4 | 8         | 9.6        | nC               |

A. The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user's specific board design.

B. The power dissipation  $P_D$  is based on  $T_{J(\text{MAX})}=150^\circ\text{C}$ , using  $\leqslant 10\text{s}$  junction-to-ambient thermal resistance.

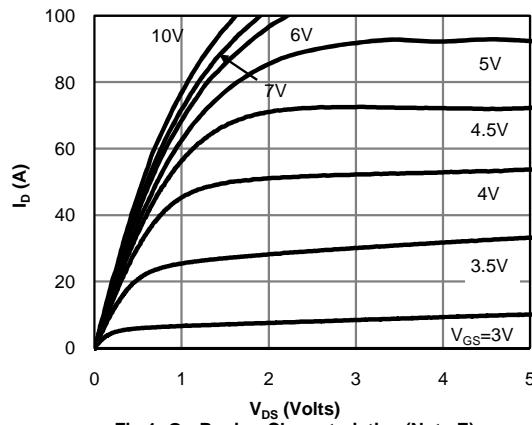
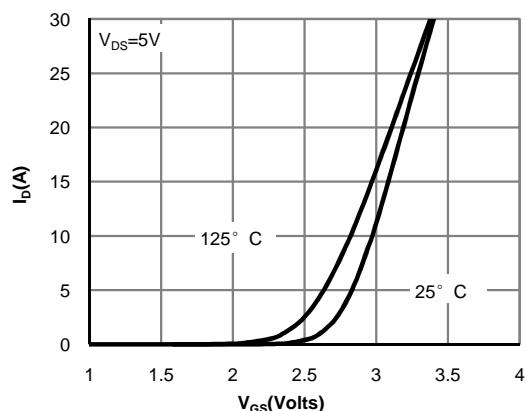
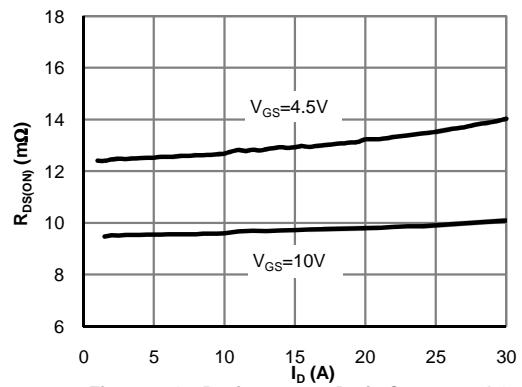
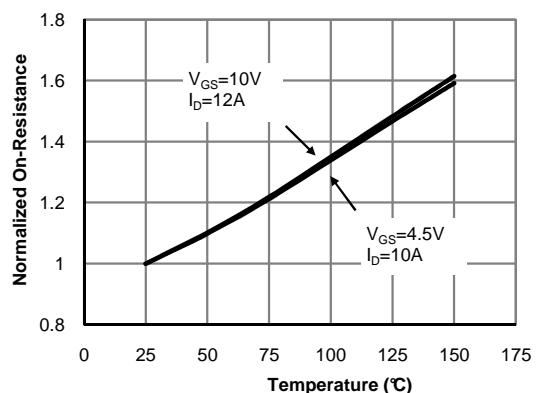
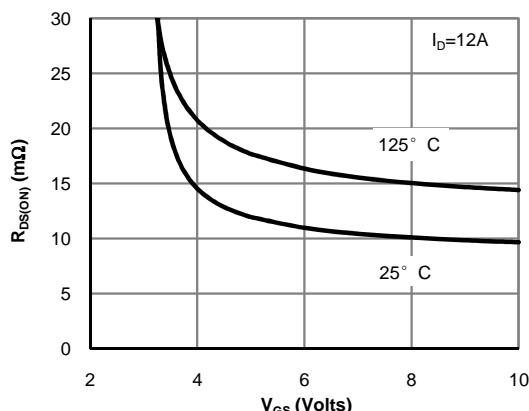
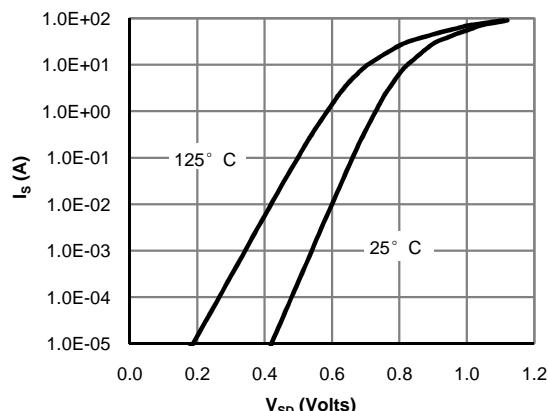
C. Repetitive rating, pulse width limited by junction temperature  $T_{J(\text{MAX})}=150^\circ\text{C}$ . Ratings are based on low frequency and duty cycles to keep initial  $T_J=25^\circ\text{C}$ .

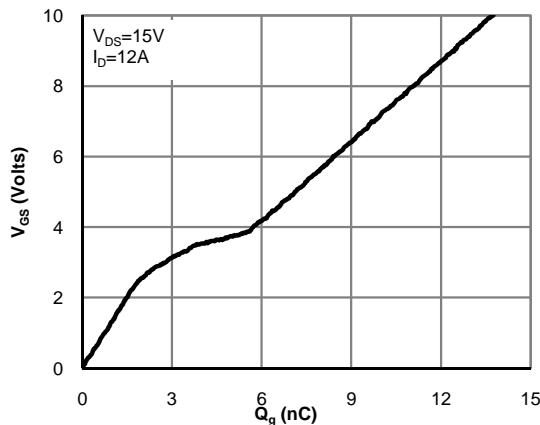
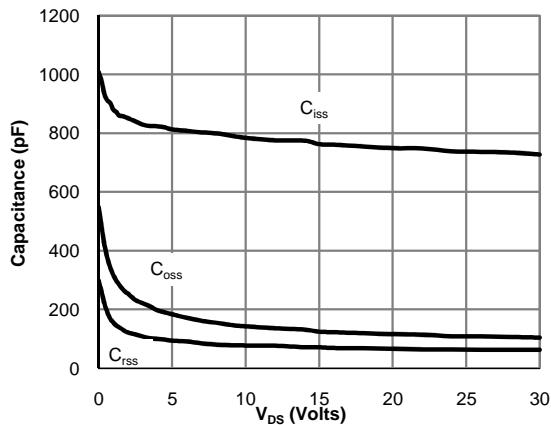
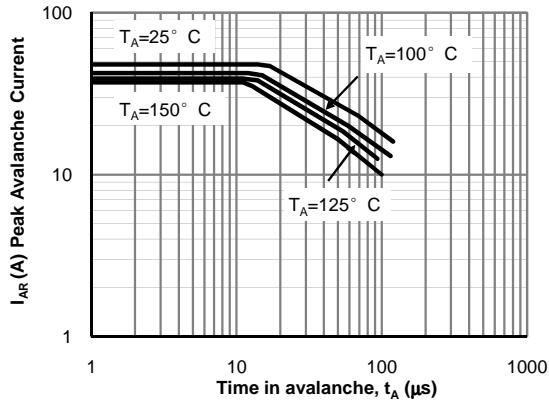
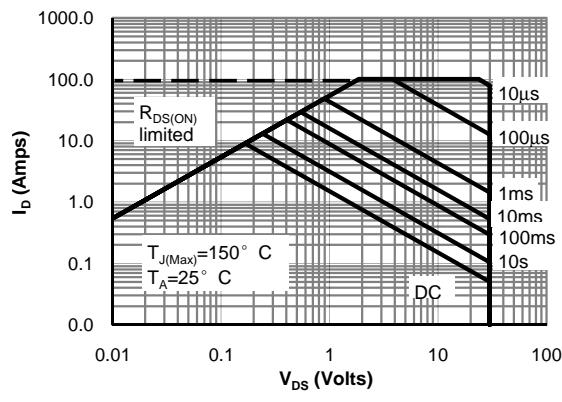
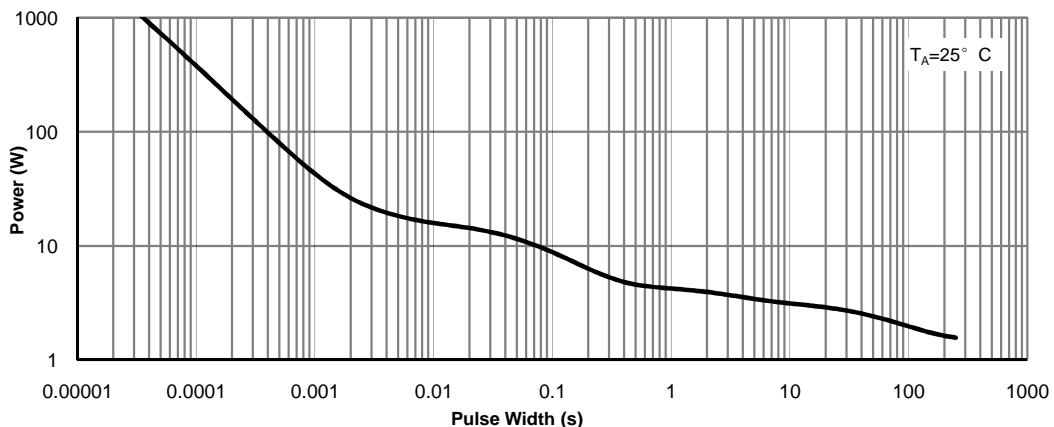
D. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using  $<300\mu\text{s}$  pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, assuming a maximum junction temperature of  $T_{J(\text{MAX})}=150^\circ\text{C}$ . The SOA curve provides a single pulse rating.

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**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

**Fig 1: On-Region Characteristics (Note E)**

**Figure 2: Transfer Characteristics (Note E)**

**Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)**

**Figure 4: On-Resistance vs. Junction Temperature (Note E)**

**Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)**

**Figure 6: Body-Diode Characteristics (Note E)**

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

**Figure 7: Gate-Charge Characteristics**

**Figure 8: Capacitance Characteristics**

**Figure 9: Single Pulse Avalanche capability (Note C)**

**Figure 10: Maximum Forward Biased Safe Operating Area (Note F)**

**Figure 11: Single Pulse Power Rating Junction-to-Ambient (Note F)**

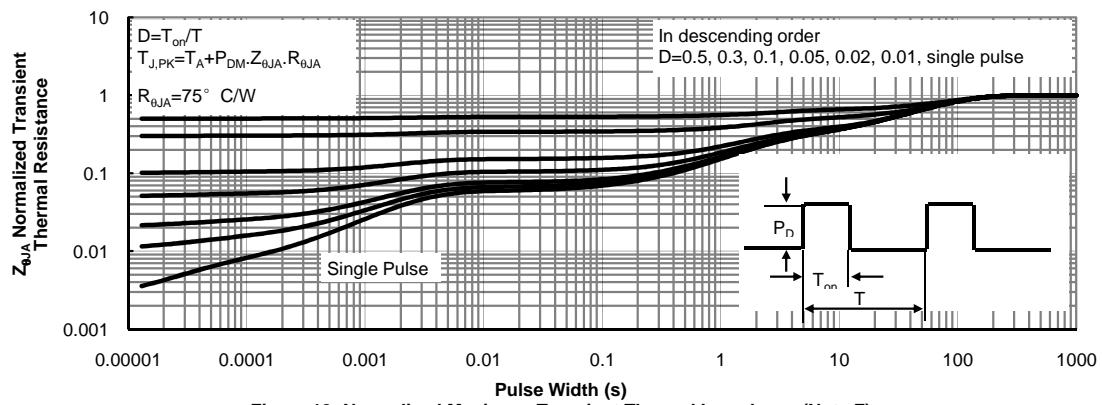
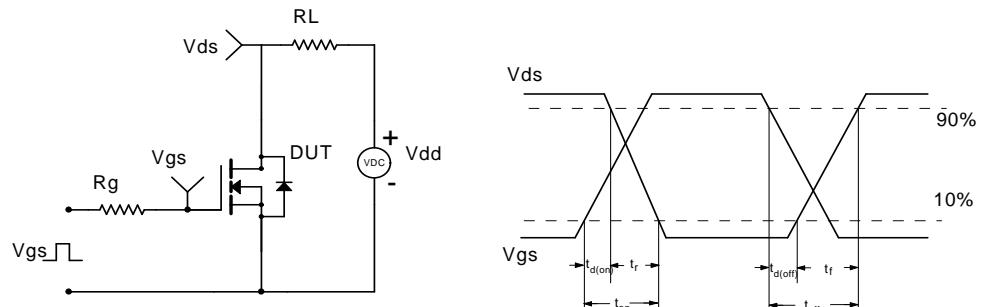
**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**


Figure 12: Normalized Maximum Transient Thermal Impedance (Note F)

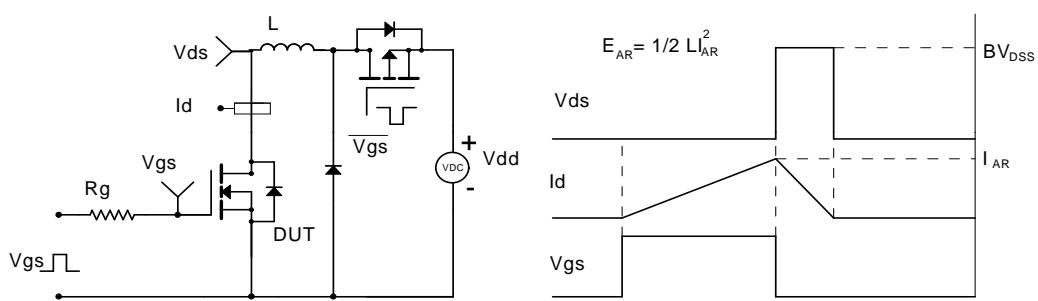
### Gate Charge Test Circuit & Waveform



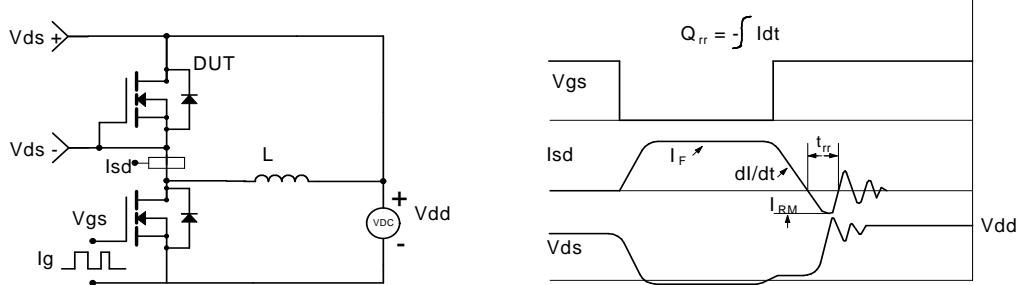
### Resistive Switching Test Circuit & Waveforms



### Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



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